



Product Change Notification

Change Notification #: 115596 - 00

Change Title: Intel® Server System R1208WT2GSR,
Intel® Server System R1208WTTGSR,
Intel® Server System R1304WTTGSR,
Intel® Server System R1304WT2GSR,
Intel® Server System R2308WTTYSR,
Intel® Server System R2208WTTYSR,
Intel® Server System R2208WT2YSR,
Intel® Server System R2208WTTYC1R,
Intel® Server System R2224WTTYSR,
Intel® Server System R2312WTTYSR,
Intel® Server System R2312WTXXX,
Intel® Server System R2000WTXXX,
Intel® Server System R1304WTXXX and
Intel® Server System R1208WTXXX ,
PCN 115596-00, Label,
Update regulatory label to include BSMI
RoHS text logo

Date of Publication: June 20, 2017

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	Jul 07, 2017
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the products listed on the Products affected/Intel ordering codes below

1. Update the packaging regulatory label, by replacing the BSMI logo with the new version that includes RoHS text to the label.

Please see Figure-1 and Figure-2 below for details.



Figure-1: Pre-Change



Figure-2: Post-change

- Update the regulatory label, by replacing the BSMI logo with the new version that includes RoHS text to the label. Please see Figure-3 and Figure-4 below for details.



Figure-3: Pre-Change



Figure-4: Post-Change

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R2000WTXXX	936021	H46995-006	H46995-007
R2312WTXXX	936022	H46998-004	H46998-005
R1304WTXXX	936121	H46985-002	H46985-003
R1208WTXXX	936187	H46988-002	H46988-003
R2208WTTYSR	943826	J11484-008	J11484-009
R2208WT2YSR	943827	J11485-007	J11485-008
R2208WTTYC1R	943828	J11487-007	J11487-008
R2308WTTYSR	943829	J11493-008	J11493-009
R2224WTTYSR	943831	J11492-008	J11492-009
R1304WTTGSR	943891	J11482-006	J11482-007
R1304WT2GSR	943892	J11483-006	J11483-007
R1208WTTGSR	943893	J11481-007	J11481-008
R1208WT2GSR	943894	J11465-006	J11465-007
R2312WTTYSR	951229	J11495-009	J11495-010

PCN Revision History:

Date of Revision:

June 20, 2017

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

115596 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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